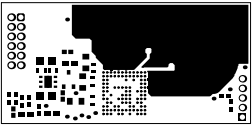


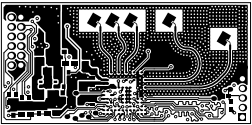
Top Overlay

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Top Overlay	TID #: TIDEP-01033		
PLOT NAME = Top Overlay	GENERATED : 9/23/2024 9:50:01 PM		TEXAS INSTRUMENTS



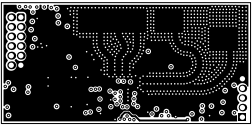
Top Solder

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Top Solder Mask	TID #: TIDEP-01033		
PLOT NAME = Top Solder Mask	GENERATED : 9/23/2024 9:50:01 PM		TEXAS INSTRUMENTS



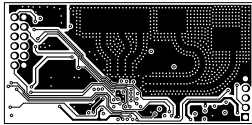
Top Layer

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Top Layer	TID #: TIDEP-01033		
PLOT NAME = Top Layer	GENERATED : 9/23/2024 9:50:01 PM		TEXAS INSTRUMENTS



L2_GND1

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Signal Layer 1	TID #: TIDEP-01033		
PLOT NAME = Signal Layer 1	GENERATED : 9/23/2024 9:50:01 PM		TEXAS INSTRUMENTS



L3_SIG1

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Signal Layer 2	TID #: TIDEP-01033		
PLOT NAME = Signal Layer 2	GENERATED : 9/23/2024 9:50:02 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Signal Layer 3	TID #: TIDEP-01033		
PLOT NAME = Signal Layer 3	GENERATED : 9/23/2024 9:50:02 PM		TEXAS INSTRUMENTS



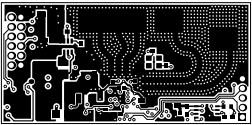
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Signal Layer 4	TID #: TIDEP-01033		
PLOT NAME = Signal Layer 4	GENERATED : 9/23/2024 9:50:02 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Signal Layer 5	TID #: TIDEP-01033		
PLOT NAME = Signal Layer 5	GENERATED : 9/23/2024 9:50:02 PM		TEXAS INSTRUMENTS

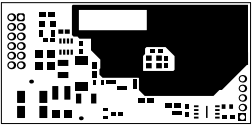


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Signal Layer 6	TID #: TIDEP-01033		
PLOT NAME = Signal Layer 6	GENERATED : 9/23/2024 9:50:03 PM		TEXAS INSTRUMENTS



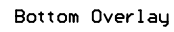
Bottom Layer

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Bottom Layer	TID #: TIDEP-01033		
PLOT NAME = Bottom Layer	GENERATED : 9/23/2024 9:50:03 PM		TEXAS INSTRUMENTS

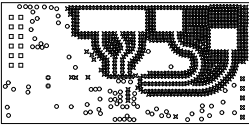


Bottom Solder

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Bottom Solder Mask	TID #: TIDEP-01033		
PLOT NAME = Bottom Solder Mask	GENERATED : 9/23/2024 9:50:03 PM		TEXAS INSTRUMENTS

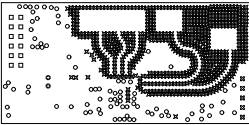


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Bottom Overlay	TID #: TIDEP-01033		
PLOT NAME = Bottom Overlay	GENERATED : 9/23/2024 9:50:03 PM		TEXAS INSTRUMENTS



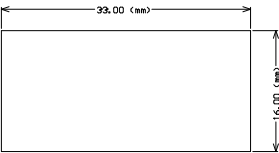
Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape	Template	Hole Tolerance (+)	Hole Tolerance (-)
⊕	2	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v50h20m50mx0		
⊗	5	27.56mil (0.700mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>		
□	12	27.56mil (0.700mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>	1.97mil (0.050mm)	1.97mil (0.050mm)
○	84	8.00mil (0.203mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v46h20m0mx0		
⊗	685	8.00mil (0.203mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v46h20m0mx0<Tol8-8>	3.00mil (0.076mm)	3.00mil (0.076mm)
	788 Total									

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Drill Drawing	TID #: TIDEP-01033		
PLOT NAME = Drill Drawing	GENERATED : 9/23/2024 9:50:03 PM	TEXAS INSTRUMENTS	



Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape	Template	Hole Tolerance (+)	Hole Tolerance (-)
⊕	2	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v50h20m50mx0		
⊗	5	27.56mil (0.700mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>		
□	12	27.56mil (0.700mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>	1.97mil (0.050mm)	1.97mil (0.050mm)
○	84	8.00mil (0.203mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v46h20m0mx0		
⊗	685	8.00mil (0.203mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v46h20m0mx0<Tol8-8>	3.00mil (0.076mm)	3.00mil (0.076mm)
	788 Total									

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Drill Drawing	TID #: TIDEP-01033		
PLOT NAME = Drill Drawing	GENERATED : 9/23/2024 9:50:04 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDEP-01033	REV: A	SUN REV: Not in version control
LAYER NAME = Board Dimensions	TID #: TIDEP-01033		
PLOT NAME = Board Dimensions	GENERATED : 9/23/2024 9:50:06 PM		TEXAS INSTRUMENTS

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